2-input EXCLUSIVE-OR gate Rev. 05 — 4 July 2007

#### **General description** 1.

74AHC1G86 and 74AHCT1G86 are high-speed Si-gate CMOS devices. They provide a 2-input EXCLUSIVE-OR function.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

#### 2. **Features**

- Symmetrical output impedance
- High noise immunity
- ESD protection:
  - HBM JESD22-A114E: exceeds 2000 V
  - MM JESD22-A115-A: exceeds 200 V
  - CDM JESD22-C101C: exceeds 1000 V
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options
- Specified from –40 °C to +125 °C

#### **Ordering information** 3.

#### Table 1. **Ordering information**

| Type number  | Package           |        |  |          |  |  |  |  |  |
|--------------|-------------------|--------|--|----------|--|--|--|--|--|
|              | Temperature range | Name   | Description  | Version  |  |  |  |  |  |
| 74AHC1G86GW  | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 |  |  |  |  |  |
| 74AHCT1G86GW |                   |        | ···· <b>,</b>  |          |  |  |  |  |  |
| 74AHC1G86GV  | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads                               | SOT753   |  |  |  |  |  |
| 74AHCT1G86GV |                   |        |  |          |  |  |  |  |  |



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### 4. Marking

| Table 2.   Marking codes |              |
|--------------------------|--------------|
| Type number              | Marking code |
| 74AHC1G86GW              | AH           |
| 74AHCT1G86GW             | СН           |
| 74AHC1G86GV              | A86          |
| 74AHCT1G86GV             | C86          |

## 5. Functional diagram



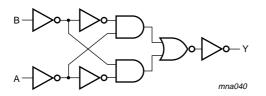
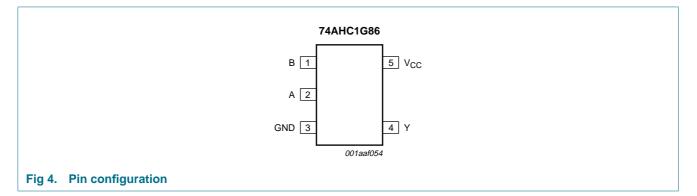


Fig 3. Logic diagram

## 6. Pinning information

### 6.1 Pinning



## 6.2 Pin description

| Table 3.        | Pin description |                |
|-----------------|-----------------|----------------|
| Symbol          | Pin             | Description    |
| В               | 1               | data input     |
| A               | 2               | data input     |
| GND             | 3               | ground (0 V)   |
| Y               | 4               | data output    |
| V <sub>CC</sub> | 5               | supply voltage |

## 7. Functional description

#### Table 4.Function table

*H* = *HIGH* voltage level; *L* = *LOW* voltage level

| Inputs |   | Output |
|--------|---|--------|
| Α      | В | Y      |
| L      | L | L      |
| L      | н | Н      |
| н      | L | Н      |
| Н      | Н | L      |

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| V <sub>CC</sub> supply voltage-0.5+7.0V $V_1$ input voltage-0.5+7.0V $I_{IK}$ input clamping current $V_1 < -0.5$ V-20-mA $I_{OK}$ output clamping current $V_0 < -0.5$ V or $V_O > V_{CC} + 0.5$ V[1]- $\pm 20$ mA $I_O$ output current $-0.5$ V < $V_O < V_{CC} + 0.5$ V1- $\pm 20$ mA $I_O$ output current $-0.5$ V < $V_O < V_{CC} + 0.5$ V- $\pm 25$ mA $I_{CC}$ supply current-75mA $I_{GND}$ ground current-75-mA $T_{stg}$ storage temperature-65+150°C $P_{tot}$ total power dissipation $T_{amb} = -40$ °C to +125 °C[2]-250mW | Symbol           | Parameter               | Conditions  | Min          | Max  | Unit |
|--|------------------|-------------------------|---|--------------|------|------|
| InInput clamping current $V_1 < -0.5$ V $-20$ $-$ mAI_{OK}output clamping current $V_0 < -0.5$ V or $V_0 > V_{CC} + 0.5$ V $(1)$ $\pm 20$ mAI_Ooutput current $-0.5$ V $< V_0 < V_{CC} + 0.5$ V $ \pm 25$ mAI_{CC}supply current $-0.5$ V $< V_0 < V_{CC} + 0.5$ V $ \pm 25$ mAI_{GND}ground current $-75$ $-$ mAT_{stg}storage temperature $-65$ $+150$ $^{\circ}C$   | -                | supply voltage          |   | -0.5         | +7.0 | V    |
| IncOutput clamping current $V_O < -0.5 V \text{ or } V_O > V_{CC} + 0.5 V$ [1] - $\pm 20$ mAI_Ooutput current $-0.5 V < V_O > V_{CC} + 0.5 V$ - $\pm 25$ mAI_{CC}supply current-75mAI_{GND}ground current-75-mAT_{stg}storage temperature-65+150°C   |                  | input voltage           |   | -0.5         | +7.0 | V    |
| Ioroutput current $-0.5 V < V_O < V_{CC} + 0.5 V$ $ \pm 25$ mAI_{CC}supply current $-0.5 V < V_O < V_{CC} + 0.5 V$ $ \pm 25$ mAI_{GND}ground current $-75$ $-$ mAT_{stg}storage temperature $-65$ $+150$ $^{\circ}C$   | I <sub>IK</sub>  | input clamping current  | V <sub>1</sub> < -0.5 V   | -20          | -    | mA   |
| $I_{CC}$ supply current-75mA $I_{GND}$ ground current-75-mA $T_{stg}$ storage temperature-65+150°C   | Ι <sub>ΟΚ</sub>  | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V                    | <u>[1]</u> - | ±20  | mA   |
| $I_{GND}$ ground current $-75$ $-$ mA $T_{stg}$ storage temperature $-65$ $+150$ $^{\circ}C$   | I <sub>O</sub>   | output current          | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | -            | ±25  | mA   |
| $T_{stg}$ storage temperature $-65 +150$ °C  | I <sub>CC</sub>  | supply current          |   | -            | 75   | mA   |
|  | I <sub>GND</sub> | ground current          |   | -75          | -    | mA   |
| $P_{tot}$ total power dissipation $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ [2] - 250 mW  | T <sub>stg</sub> | storage temperature     |   | -65          | +150 | °C   |
|  | P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$                               | [2] _        | 250  | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K.

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# 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter             | Conditions                   | 74  | AHC1G | 86       | 74  | Unit |          |      |
|-----------------------|-----------------------|------------------------------|-----|-------|----------|-----|------|----------|------|
|                       |                       |                              | Min | Тур   | Max      | Min | Тур  | Max      |      |
| V <sub>CC</sub>       | supply voltage        |                              | 2.0 | 5.0   | 5.5      | 4.5 | 5.0  | 5.5      | V    |
| VI                    | input voltage         |                              | 0   | -     | 5.5      | 0   | -    | 5.5      | V    |
| Vo                    | output voltage        |                              | 0   | -     | $V_{CC}$ | 0   | -    | $V_{CC}$ | V    |
| T <sub>amb</sub>      | ambient temperature   |                              | -40 | +25   | +125     | -40 | +25  | +125     | °C   |
| $\Delta t / \Delta V$ | input transition rise | $V_{CC}$ = 3.3 V $\pm$ 0.3 V | -   | -     | 100      | -   | -    | -        | ns/V |
|                       | and fall rate         | $V_{CC}=5.0~V\pm0.5~V$       | -   | -     | 20       | -   | -    | 20       | ns/V |

## **10. Static characteristics**

#### Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol                     | Parameter                  | Conditions   |      | 25 °C |      | −40 °C to +85 °C |      | –40 °C to +125 °C |      | Unit |
|----------------------------|----------------------------|--|------|-------|------|------------------|------|-------------------|------|------|
|                            |                            |  | Min  | Тур   | Max  | Min              | Мах  | Min               | Мах  |      |
| For type                   | 74AHC1G86                  | 1  |      |       |      |                  |      |                   |      |      |
| VIH                        | HIGH-level                 | $V_{CC} = 2.0 V$   | 1.5  | -     | -    | 1.5              | -    | 1.5               | -    | V    |
|                            | input voltage              | V <sub>CC</sub> = 3.0 V  | 2.1  | -     | -    | 2.1              | -    | 2.1               | -    | V    |
|                            |                            | V <sub>CC</sub> = 5.5 V  | 3.85 | -     | -    | 3.85             | -    | 3.85              | -    | V    |
| V <sub>IL</sub>            | LOW-level<br>input voltage | V <sub>CC</sub> = 2.0 V  | -    | -     | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|                            |                            | $V_{CC} = 3.0 V$   | -    | -     | 0.9  | -                | 0.9  | -                 | 0.9  | V    |
|                            |                            | $V_{CC} = 5.5 V$   | -    | -     | 1.65 | -                | 1.65 | -                 | 1.65 | V    |
| V <sub>OH</sub> HIGH-level |                            | $V_{I} = V_{IH} \text{ or } V_{IL}$                              |      |       |      |                  |      |                   |      |      |
|                            | output voltage             | $I_{O}$ = –50 $\mu A;$ $V_{CC}$ = 2.0 V                          | 1.9  | 2.0   | -    | 1.9              | -    | 1.9               | -    | V    |
|                            |                            | $I_O$ = –50 $\mu A; V_{CC}$ = 3.0 V                              | 2.9  | 3.0   | -    | 2.9              | -    | 2.9               | -    | V    |
|                            |                            | $I_O$ = –50 $\mu A; V_{CC}$ = 4.5 V                              | 4.4  | 4.5   | -    | 4.4              | -    | 4.4               | -    | V    |
|                            |                            | $I_{O}$ = –4.0 mA; $V_{CC}$ = 3.0 V                              | 2.58 | -     | -    | 2.48             | -    | 2.40              | -    | V    |
|                            |                            | $I_{O}$ = –8.0 mA; $V_{CC}$ = 4.5 V                              | 3.94 | -     | -    | 3.8              | -    | 3.70              | -    | V    |
| V <sub>OL</sub>            | LOW-level                  | $V_I = V_{IH} \text{ or } V_{IL}$                                |      |       |      |                  |      |                   |      |      |
|                            | output voltage             | $I_O = 50 \ \mu\text{A}; \ V_{CC} = 2.0 \ V$                     | -    | 0     | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                            |                            | $I_{O} = 50 \ \mu A; \ V_{CC} = 3.0 \ V$                         | -    | 0     | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                            |                            | $I_O = 50 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$                     | -    | 0     | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                            |                            | $I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V                               | -    | -     | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
|                            |                            | $I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V                               | -    | -     | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
| l <sub>l</sub>             | input leakage<br>current   | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 0 V to 5.5 V | -    | -     | 0.1  | -                | 1.0  | -                 | 2.0  | μΑ   |
| I <sub>CC</sub>            | supply current             |  | -    | -     | 1.0  | -                | 10   | -                 | 40   | μΑ   |
| CI                         | input<br>capacitance       |  | -    | 1.5   | 10   | -                | 10   | -                 | 10   | pF   |

74AHC\_AHCT1G86\_5

2-input EXCLUSIVE-OR gate

| Symbol                    | Parameter                                     | Conditions   |      | 25 °C |      | _40 °C | to +85 °C | –40 °C to +125 °C |      | Unit |
|---------------------------|---|--|------|-------|------|--------|-----------|-------------------|------|------|
|                           |   |  | Min  | Тур   | Max  | Min    | Max       | Min               | Max  | 1    |
| For type                  | 74AHCT1G86                                    |  |      |       |      |        |           |                   |      |      |
| V <sub>IH</sub>           | HIGH-level<br>input voltage                   | $V_{CC}$ = 4.5 V to 5.5 V  | 2.0  | -     | -    | 2.0    | -         | 2.0               | -    | V    |
| V <sub>IL</sub>           | LOW-level<br>input voltage                    | $V_{CC}$ = 4.5 V to 5.5 V  | -    | -     | 0.8  | -      | 0.8       | -                 | 0.8  | V    |
| V <sub>OH</sub>           | HIGH-level                                    | $V_{\text{I}}$ = $V_{\text{IH}}$ or $V_{\text{IL}};$ $V_{\text{CC}}$ = 4.5 V                         |      |       |      |        |           |                   |      |      |
|                           | output voltage                                | I <sub>O</sub> = -50 μA  | 4.4  | 4.5   | -    | 4.4    | -         | 4.4               | -    | V    |
|                           |   | I <sub>O</sub> = -8.0 mA   | 3.94 | -     | -    | 3.8    | -         | 3.70              | -    | V    |
| V <sub>OL</sub> LOW-level | $V_{I}$ = $V_{IH}$ or $V_{IL};V_{CC}$ = 4.5 V |  |      |       |      |        |           |                   |      |      |
|                           | output voltage                                | I <sub>O</sub> = 50 μA   | -    | 0     | 0.1  | -      | 0.1       | -                 | 0.1  | V    |
|                           |   | I <sub>O</sub> = 8.0 mA  | -    | -     | 0.36 | -      | 0.44      | -                 | 0.55 | V    |
| I                         | input leakage<br>current                      | $V_1 = 5.5 V \text{ or GND};$<br>$V_{CC} = 0 V \text{ to } 5.5 V$                                    | -    | -     | 0.1  | -      | 1.0       | -                 | 2.0  | μΑ   |
| I <sub>CC</sub>           | supply current                                | $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A};$<br>$V_{CC} = 5.5 \text{ V}$                        | -    | -     | 1.0  | -      | 10        | -                 | 40   | μΑ   |
| $\Delta I_{CC}$           | additional supply current                     | per input pin; $V_I = 3.4 V$ ;<br>other inputs at $V_{CC}$ or GND;<br>$I_O = 0 A$ ; $V_{CC} = 5.5 V$ | -    | -     | 1.35 | -      | 1.5       | -                 | 1.5  | mA   |
| CI                        | input<br>capacitance                          |  | -    | 1.5   | 10   | -      | 10        | -                 | 10   | pF   |

# **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For waveform see <u>Figure 5</u>. For test circuit see <u>Figure 6</u>.

|                                      |                                     |   | -          |     |       |      |          |           |                          |      |      |
|--------------------------------------|-------------------------------------|---|------------|-----|-------|------|----------|-----------|--------------------------|------|------|
| Symbol                               | Parameter                           | Conditions  |            |     | 25 °C |      | -40 °C ∱ | to +85 °C | <b>−40 °C to +125 °C</b> |      | Unit |
|                                      |                                     |   |            | Min | Тур   | Max  | Min      | Max       | Min                      | Max  |      |
| For type                             | 74AHC1G86                           |   |            |     |       |      |          |           |                          |      |      |
| t <sub>pd</sub> propagation<br>delay |                                     | A and B to Y  | <u>[1]</u> |     |       |      |          |           |                          |      |      |
|                                      | $V_{CC}$ = 3.0 V to 3.6 V           | [2]   |            |     |       |      |          |           |                          |      |      |
|                                      |                                     | C <sub>L</sub> = 15 pF  |            | -   | 4.0   | 11.0 | 1.0      | 13.0      | 1.0                      | 14.0 | ns   |
|                                      |                                     | C <sub>L</sub> = 50 pF  |            | -   | 5.8   | 14.5 | 1.0      | 16.5      | 1.0                      | 18.5 | ns   |
|                                      |                                     | $V_{CC}$ = 4.5 V to 5.5 V   | [3]        |     |       |      |          |           |                          |      |      |
|                                      |                                     | C <sub>L</sub> = 15 pF  |            | -   | 3.4   | 6.8  | 1.0      | 8.0       | 1.0                      | 8.5  | ns   |
|                                      |                                     | C <sub>L</sub> = 50 pF  |            | -   | 4.9   | 8.8  | 1.0      | 10.0      | 1.0                      | 11.5 | ns   |
| C <sub>PD</sub>                      | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$ | <u>[4]</u> | -   | 9     | -    | -        | -         | -                        | -    | pF   |

2-input EXCLUSIVE-OR gate

| GND = 0         | $V; t_r = t_f = \leq 3.$            | 0 ns. For waveform see <mark>Fig</mark>   | gure 5.    | For te | st circu | it see <mark>F</mark> | igure 6.                |     |                 |           |      |
|-----------------|-------------------------------------|---|------------|--------|----------|-----------------------|-------------------------|-----|-----------------|-----------|------|
| Symbol          | Parameter                           | Conditions  |            | 25 °C  |          |                       | <b>−40 °C to +85 °C</b> |     | <b>−40</b> °C t | o +125 °C | Unit |
|                 |                                     |   |            | Min    | Тур      | Max                   | Min                     | Max | Min             | Max       |      |
| For type        | 74AHCT1G8                           | 6   |            |        |          |                       |                         |     |                 |           |      |
| t <sub>pd</sub> | propagation<br>delay                | A and B to Y  | [1]        |        |          |                       |                         |     |                 |           |      |
|                 |                                     | $V_{CC}$ = 4.5 V to 5.5 V   | [3]        |        |          |                       |                         |     |                 |           |      |
|                 |                                     | C <sub>L</sub> = 15 pF  |            | -      | 3.5      | 6.9                   | 1.0                     | 8.0 | 1.0             | 9.0       | ns   |
|                 |                                     | C <sub>L</sub> = 50 pF  |            | -      | 5.0      | 7.9                   | 1.0                     | 9.0 | 1.0             | 10.5      | ns   |
| C <sub>PD</sub> | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$ | <u>[4]</u> | -      | 11       | -                     | -                       | -   | -               | -         | pF   |

#### Table 8. Dynamic characteristics ... continued

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] Typical values are measured at  $V_{CC}$  = 3.3 V.

[3] Typical values are measured at  $V_{CC}$  = 5.0 V.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts.

## 12. Waveforms

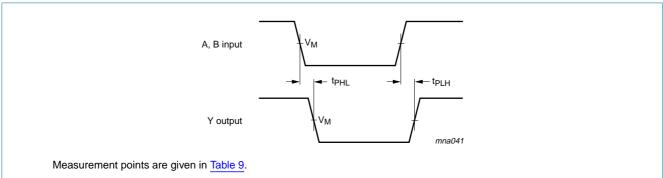


Fig 5. The input (A and B) to output (Y) propagation delays

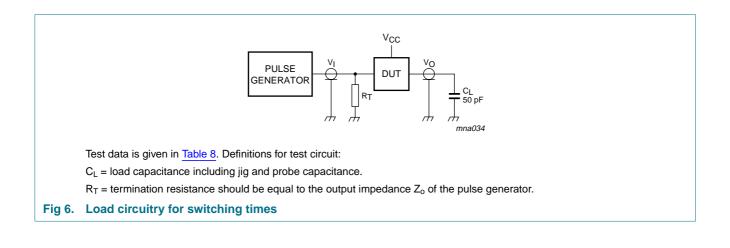
#### Table 9. **Measurement points**

| Туре       | Input                  | Output              |                     |
|------------|------------------------|---------------------|---------------------|
|            | VI                     | V <sub>M</sub>      | V <sub>M</sub>      |
| 74AHC1G86  | GND to V <sub>CC</sub> | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT1G86 | GND to 3.0 V           | 1.5 V               | $0.5 	imes V_{CC}$  |

### **NXP Semiconductors**

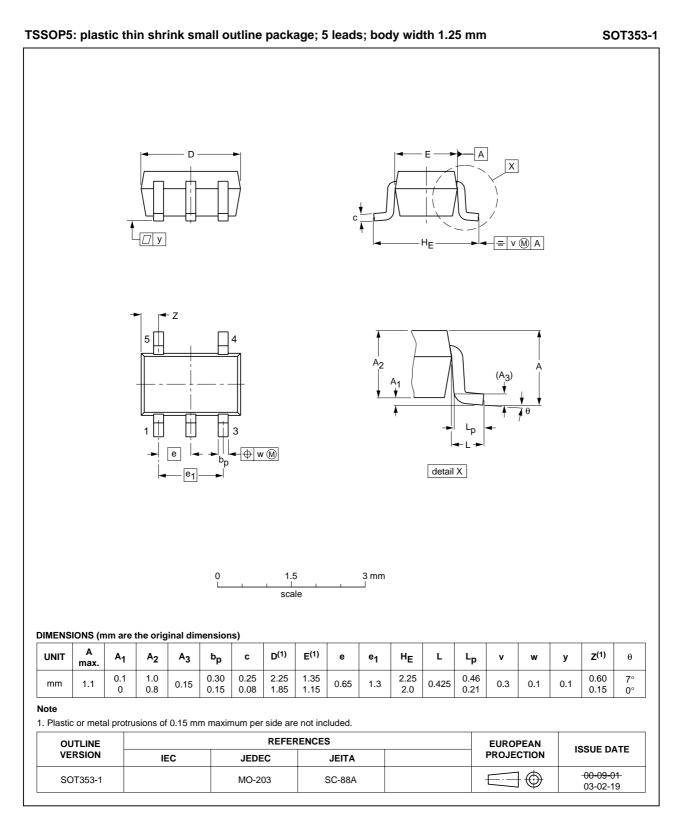
# 74AHC1G86; 74AHCT1G86

#### 2-input EXCLUSIVE-OR gate



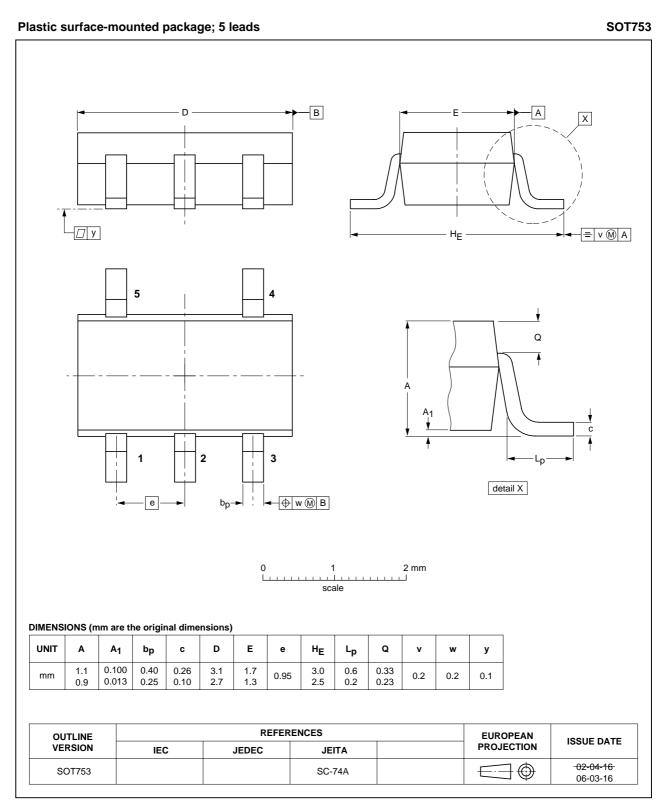
2-input EXCLUSIVE-OR gate

## 13. Package outline



#### Fig 7. Package outline SOT353-1 (TSSOP5)

2-input EXCLUSIVE-OR gate



#### Fig 8. Package outline SOT753 (SC-74A)

2-input EXCLUSIVE-OR gate

# 14. Abbreviations

| Table 10. | Abbreviations               |
|-----------|-----------------------------|
| Acronym   | Description                 |
| CDM       | Charged Device Model        |
| DUT       | Device Under Test           |
| ESD       | ElectroStatic Discharge     |
| HBM       | Human Body Model            |
| MM        | Machine Model               |
| TTL       | Transistor-Transistor Logic |

# 15. Revision history

| Table 11. | Revision | history |
|-----------|----------|---------|
|-----------|----------|---------|

|                    | · ·                                  |  |                       |                      |
|--------------------|--------------------------------------|--|-----------------------|----------------------|
| Document ID        | Release date                         | Data sheet status                                      | Change notice         | Supersedes           |
| 74AHC_AHCT1G86_5   | 20070704                             | Product data sheet                                     | -                     | 74AHC_AHCT1G86_4     |
| Modifications:     |                                      | f this data sheet has been rede<br>NXP Semiconductors. | esigned to comply w   | ith the new identity |
|                    | <ul> <li>Legal texts have</li> </ul> | ave been adapted to the new o                          | company name wher     | e appropriate.       |
|                    | <ul> <li>Package SOT</li> </ul>      | T353 changed to SOT353-1 in                            | Section 3 and Section | <u>on 13</u> .       |
|                    | <ul> <li>Quick referen</li> </ul>    | nce data and Soldering section                         | s removed.            |                      |
| 74AHC_AHCT1G86_4   | 20020606                             | Product specification                                  | -                     | 74AHC_AHCT1G86_3     |
| 74AHC_AHCT1G86_3   | 20020218                             | Product specification                                  | -                     | 74AHC_AHCT1G86_2     |
| 74AHC_AHCT1G86_2   | 20010406                             | Product specification                                  | -                     | 74AHC1G_AHCT1G86_1   |
| 74AHC1G_AHCT1G86_1 | 19990920                             | Product specification                                  | -                     | -                    |
|                    |                                      |  |                       |                      |

# **16. Legal information**

#### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 16.2 Definitions

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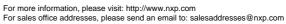
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